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Part Number: 0783210001

Status: **Active**

Overview: **DDR3 DIMM Sockets**

Description: 1.00mm Pitch DDR3 DIMM Socket, LLCR, Vertical, Through Hole, with Beveled Metal

Pins, Black Housing and Latches, 0.38µm Gold (Au) Plating, 2.67mm Solder Tail

Length, 1.57mm PCB Thickness, 240 Circuits, Lead-Free

Documents:

3D Model Packaging Specification PK-78321-001 (PDF) RoHS Certificate of Compliance (PDF)

Drawing (PDF)

Product Specification PS-78321-002-001 (PDF)

Agency Certification

CSA LR19980 UL E29179

General

Memory Module Sockets **Product Family**

Series 78321 Component Type Socket **Electrical Model** Yes JEDEC Outline MO-269

Overview **DDR3 DIMM Sockets**

Product Name DDR3 DIMM **UPC** 883906756536

Physical

Circuits (Loaded) 240 Circuits (maximum) 240 Durability (mating cycles max) 25 **Entry Angle** Vertical Flammability 94V-0 **Function Key** None **Housing Color** Black Keying to Mating Part Yes Latch Color Black Material - Metal Copper Alloy

Material - Plating Mating Gold Material - Plating Termination

Material - Resin High Temperature Thermoplastic

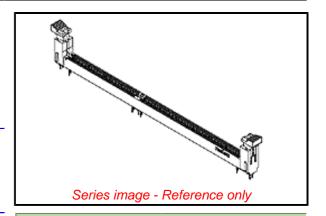
Net Weight 9.168/aPC Tail Length 2.67mm **PCB** Locator Yes **PCB** Retention Yes PCB Thickness - Recommended 1.57mm Packaging Type Tray Pitch - Mating Interface 1.00mm Pitch - Termination Interface 1.00mm Plating min - Mating 0.381µm Plating min - Termination 2.540µm Temperature Range - Operating -55° to +85°C Termination Interface: Style Through Hole

Electrical

Current - Maximum per Contact 1.0A

30V AC (RMS)/DC Voltage - Maximum

Voltage Key Center



EU ELV

Not Relevant

EU RoHS China RoHS

Compliant **REACH SVHC** Not Contained Per -ED/71/2019 (16 July

2019) **Halogen-Free**

Status

Not Low-Halogen

For more information, please visit Contact US

China ROHS Green Image ELV Not Relevant RoHS Phthalates Not Contained

Search Parts in this Series

78321 Series

Mates With

JEDEC Standard 1.27mm Modules

Downloaded from Arrow.com.

Solder Process Data

Duration at Max. Process Temperature (seconds) 005

Lead-freeProcess Capability SMC&WAVE

Max. Cycles at Max. Process Temperature 002
Process Temperature max. C 260

Material Info

Reference - Drawing Numbers

Electrical Model Document EE-78321-001, EE-78321-002

Packaging Specification PK-78321-001
Product Specification PS-78321-002-001
S-Parameter Model SP-78321-001
Sales Drawing SD-78321-001

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